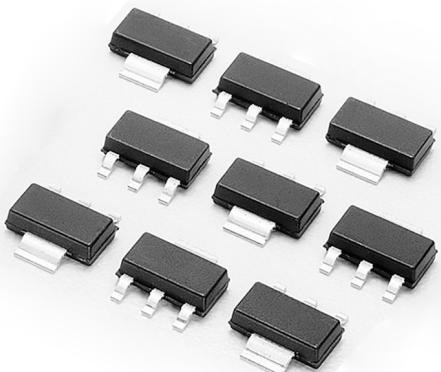




### Z0103MN, Z0107MN, Z0109MN



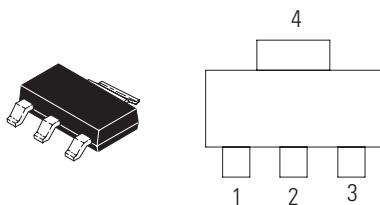
#### Description

Designed for use in solid state relays, MPU interface, TTL logic and other light industrial or consumer applications. Supplied in surface mount package for use in automated manufacturing.

#### Features

- Sensitive Gate Trigger Current in Four Trigger Modes
- Blocking Voltage to 600 V
- Glass Passivated Surface for Reliability and Uniformity
- Surface Mount Package
- These are Pb-Free Devices

#### Pin Out



#### Functional Diagram



#### Additional Information



#### Resources

### Maximum Ratings ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) ( $R_{GK} = I_{GK}$ , $T_J = 40$ to $+125^\circ\text{C}$ , Sine Wave, 50 to 60 Hz)	$V_{DRM'}$ $V_{RRM}$	600	V
On-State RMS Current (Full Sine Wave 50 to 60 Hz; $T_c = 80^\circ\text{C}$ )	$I_T$ (RMS)	1.0	A
Peak Non-repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, $T_c = 25^\circ\text{C}$ )	$I_T$ (RMS)	8.0	A
Circuit Fusing Considerations ( $t = 8.3$ ms)	$I^2t$	0.4	A2s
Average Gate Power ( $T_c = 80^\circ\text{C}$ , $t \leq 8.3$ ms)	$P_{G(AV)}$	1.0	W
Peak Gate Current ( $t \leq 20$ s, $T_J = +125^\circ\text{C}$ )	$I_{GM}$	1.0	A
Operating Junction Temperature Range @ Rated $V_{RRM}$ and $V_{DRM}$	$T_J$	-40 to +110	°C
Storage Temperature Range	$T_{stg}$	-40 to +150	°C

### Thermal Characteristics

Rating	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient PCB Mounted per Figure 1	$R_{\theta JA}$	156	°C/W
Thermal Resistance, Junction-to-Tab Measured on MT2 Tab Adjacent to Epoxy	$R_{\theta JT}$	25	°C/W
Maximum Device Temperature for Soldering Purposes for 10 Secs Maximum	$T_L$	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1.  $V_{DRM}$  and  $V_{RRM}$  for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

### Electrical Characteristics - OFF ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current (Note 3) ( $V_{AK} = \text{Rated } V_{DRM}$ or $V_{RRM}$ , $R_{GK} = 1000$ kΩ)	$T_J = 25^\circ\text{C}$	-	-	5.0	μA
	$T_J = 125^\circ\text{C}$	-	-	500	

**Electrical Characteristics - ON** ( $T_j = 25^\circ\text{C}$  unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Typ	Max	Unit
Peak On-State Voltage ( $I_{TM} = \pm 11\text{ A Peak, Pulse Width} \leq 2\text{ ms, Duty Cycle} \leq 2\%$ )	$V_{TM}$	–	–	1.8	V
Z0103MN Gate Trigger Current (Continuous dc) ( $V_D = 12\text{ V}, R_L = 30\text{ Ohms}$ )	MT2(+), G(+)	0.15	–	3.0	mA
	MT2(+), G(–)	0.15	–	3.0	
	MT2(–), G(–)	0.15	–	3.0	
	MT2(–), G(+)	0.25	–	5.0	
Z0107MN Gate Trigger Current (Continuous dc) ( $V_D = 12\text{ V}, R_L = 30\text{ Ohms}$ )	MT2(+), G(+)	0.15	–	5.0	mA
	MT2(+), G(–)	0.15	–	5.0	
	MT2(–), G(–)	0.15	–	5.0	
	MT2(–), G(+)	0.25	–	7.0	
Z0109MN Gate Trigger Current (Continuous dc) ( $V_D = 12\text{ V}, R_L = 30\text{ Ohms}$ )	MT2(+), G(+)	0.15	–	10	mA
	MT2(+), G(–)	0.15	–	10	
	MT2(–), G(–)	0.15	–	10	
	MT2(–), G(+)	0.25	–	10	
Z0103MN Latching Current ( $V_D = 12\text{ V}, I_{IG} = 1.2 \times I_{GT}$ ) ALL TYPES	MT2(+), G(+)	–	–	7.0	mA
	MT2(+), G(–)	–	–	15	
	MT2(–), G(–)	–	–	7.0	
	MT2(–), G(+)	–	–	7.0	
Z0107MN Latching Current ( $V_D = 12\text{ V}, I_{IG} = 1.2 \times I_{GT}$ ) ALL TYPES	MT2(+), G(+)	–	–	10	mA
	MT2(+), G(–)	–	–	20	
	MT2(–), G(–)	–	–	10	
	MT2(–), G(+)	–	–	10	
Z0109MN Latching Current ( $V_D = 12\text{ V}, I_{IG} = 1.2 \times I_{GT}$ ) ALL TYPES	MT2(+), G(+)	–	–	15	mA
	MT2(+), G(–)	–	–	25	
	MT2(–), G(–)	–	–	15	
	MT2(–), G(+)	–	–	15	

**Electrical Characteristics - ON** ( $T_j = 25^\circ\text{C}$  unless otherwise noted; Electricals apply in both directions) Continued

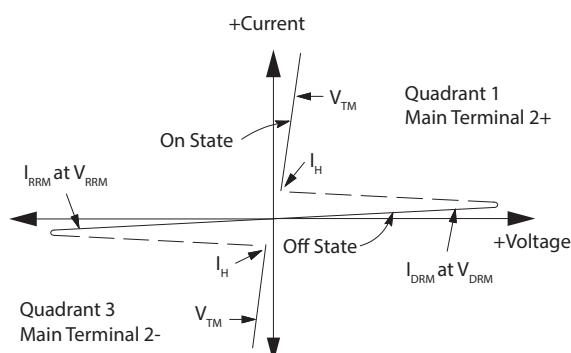
Gate Trigger Voltage (Continuous dc) ( $V_D = 12\text{ Vdc}, R_L = 30\text{ Ohms}$ )	$V_{GT}$	–	–	1.3	V
Gate-Controlled Turn-On Time, ( $V_D = \text{Rated } V_{DRM}, I_{TM} = 16\text{ A Peak, } I_G = 30\text{ mA}$ )	$t_{gt}$	0.2	–	10	μs

## Dynamic Characteristics

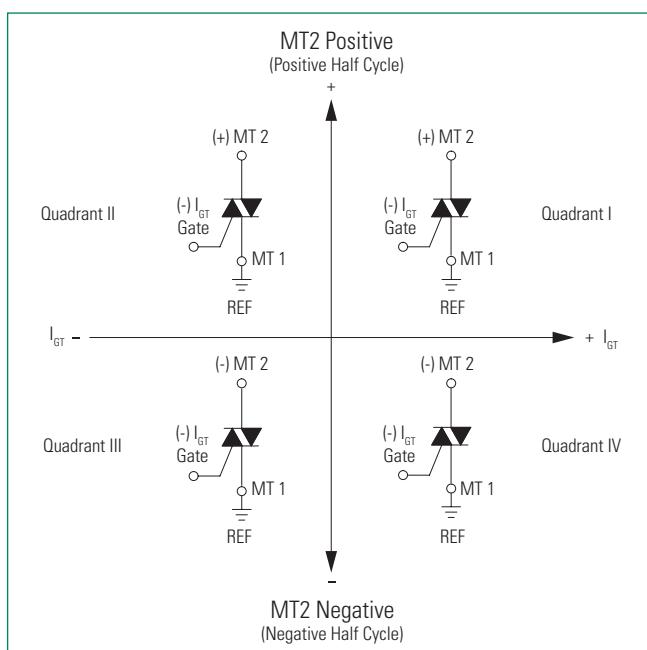
Characteristic	Symbol	Min	Typ	Max	Unit
Rate of Change of Commutating Current ( $V_D = 400$ V, $I_{TM} = 0.84$ A, Commutating $dv/dt = 1.5$ V/ $\mu$ s, Gate Open, $T_j = 110^\circ\text{C}$ , $f = 250$ Hz, with Snubber)	$dv/dt$	1.6	—	—	A/ms
Critical Rate of Rise of On-State Current ( $T_c = 110^\circ\text{C}$ , $I_G = 2 \times I_{GT}$ , $R_{GK} = 1$ k $\Omega$ )	Z0103MN	10	30	—	V/ $\mu$ s
	Z0107MN	20	60	—	
	Z0109MN	50	75	—	
Repetitive Critical Rate of Rise of On-State Current, $T_j = 125^\circ\text{C}$ Pulse Width = 20 $\mu$ s, IPKmax = 15 A, $dI/dt = 1$ A/ $\mu$ s, $f = 60$ Hz	—	—	20	A/ $\mu$ s	

## Voltage Current Characteristic of SCR

Symbol	Parameter
$V_{DRM}$	Peak Repetitive Forward Off State Voltage
$I_{DRM}$	Peak Forward Blocking Current
$V_{RRM}$	Peak Repetitive Reverse Off State Voltage
$I_{RRM}$	Peak Reverse Blocking Current
$V_{TM}$	Maximum On State Voltage
$I_H$	Holding Current

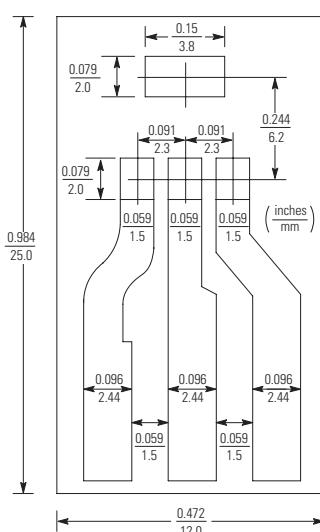


## Quadrant Definitions for a Triac



All Polarities are referenced to MT1.  
With in-phase signals (using standard AC lines) quadrants I and III are used

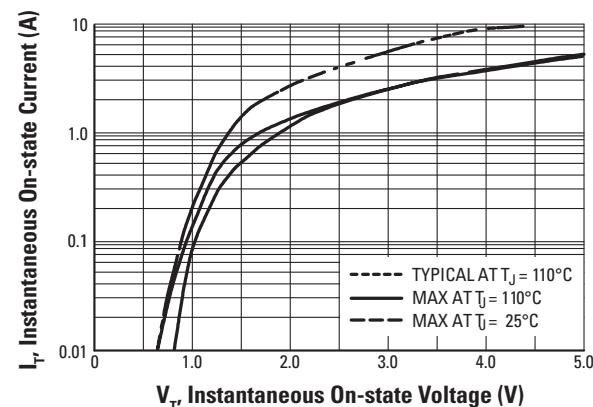
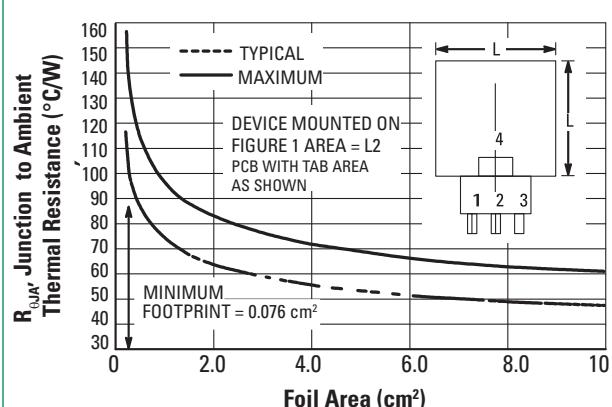
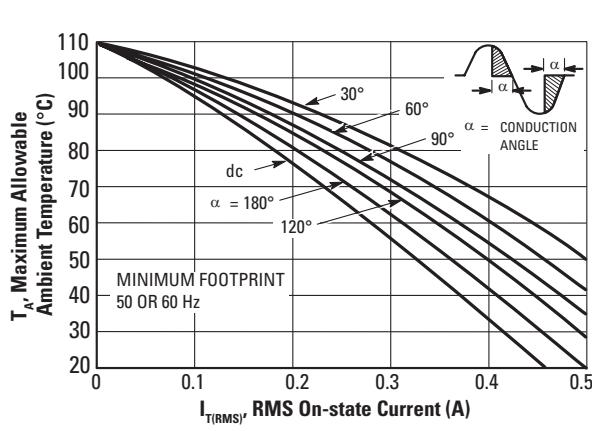
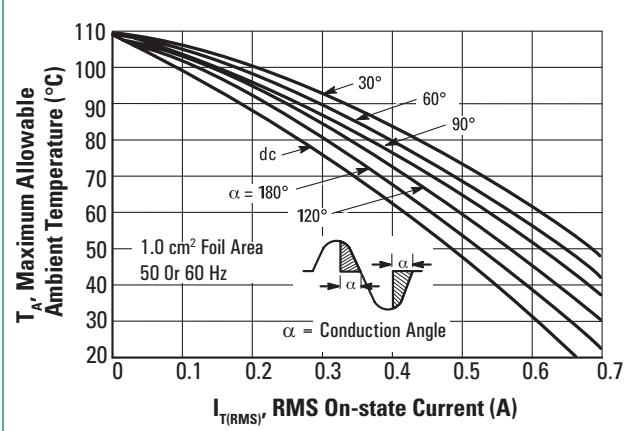
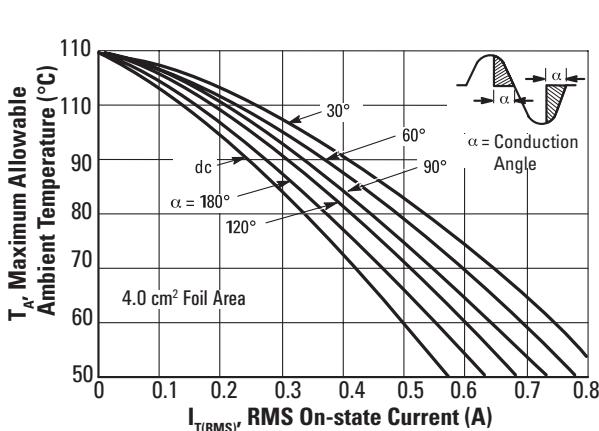
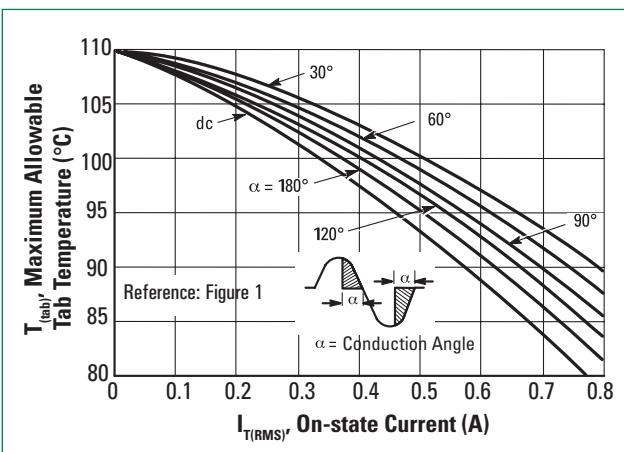
**Figure 1. PCB for Thermal Impedance and Power Testing of SOT-223**



**BOARD MOUNTED VERTICALLY IN CINCH 8840 EDGE CONNECTOR.**  
**BOARD THICKNESS = 65 MIL., FOIL THICKNESS = 2.5 MIL.**  
**MATERIAL: G10 FIBERGLASS BASE EPOXY**

# Thyristors

Surface Mount – 600V &gt; Z0103MN, Z0107MN, Z0109MN

**Figure 2. On-State Characteristics**

**Figure 3. Junction to Ambient Thermal Resistance vs Copper Tab Area**

**Figure 4. Current Derating, Minimum Pad Size Reference: Ambient Temperature**

**Figure 5. Current Derating, 1.0 cm² Square Pad Reference: Ambient Temperature**

**Figure 6. Current Derating, 2.0 cm² Square Pad Reference: Ambient Temperature**

**Figure 7. Current Derating Reference: MT2 Tab**


# Thyristors

Surface Mount – 600V &gt; Z0103MN, Z0107MN, Z0109MN

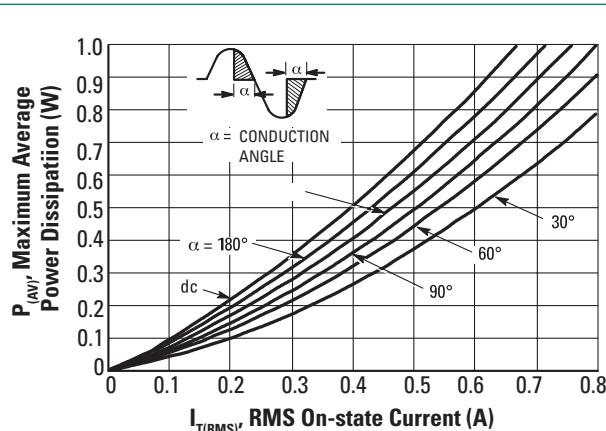
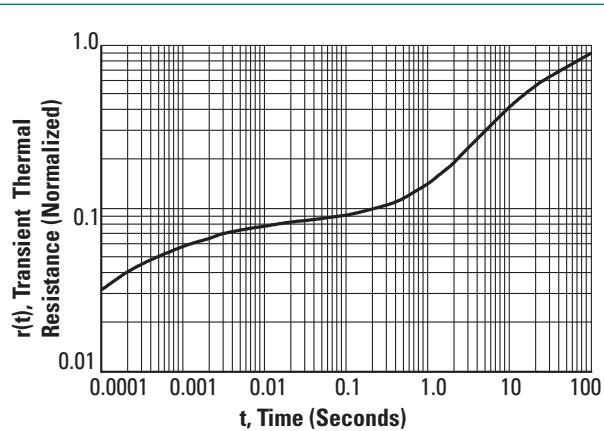
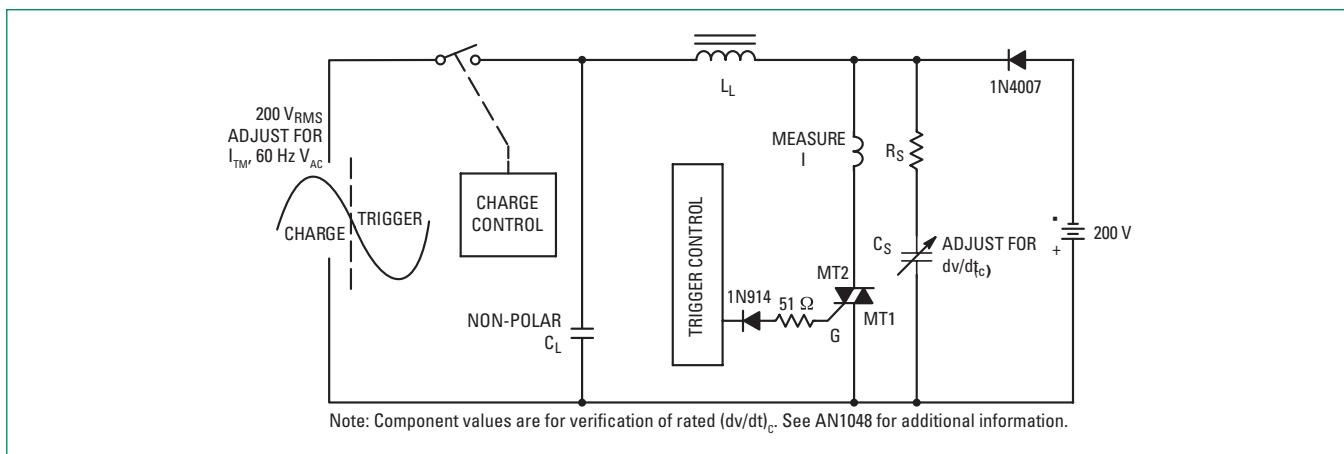
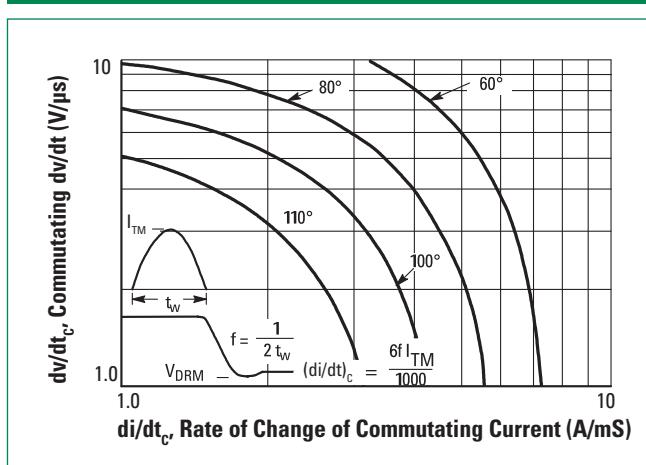
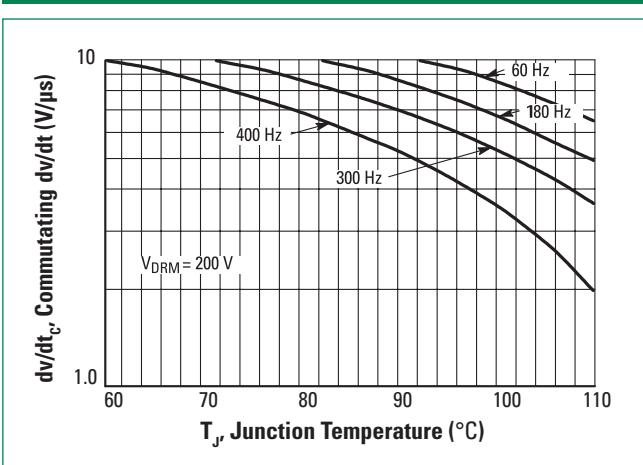
**Figure 8. Power Dissipation**

**Figure 9. Thermal Response, Device Mounted on Figure 1 Printed Circuit Board**

**Figure 10. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Voltage ( $dv/dt_c$ )**

**Figure 11. Typical Commutating  $dv/dt$  vs Current Crossing Rate and Junction Temperature**

**Figure 12. Typical Commutating  $dv/dt$  vs Junction Temperature at 0.8 Amps RMS**


Figure 13. Exponential Static dv/dt versus Gate – Main Terminal 1 Resistance

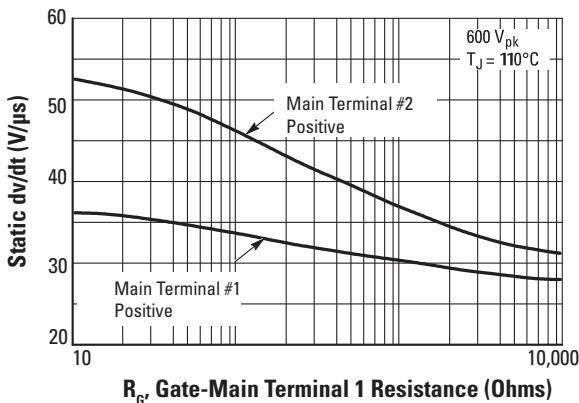


Figure 14. Typical Gate Trigger Current Variation

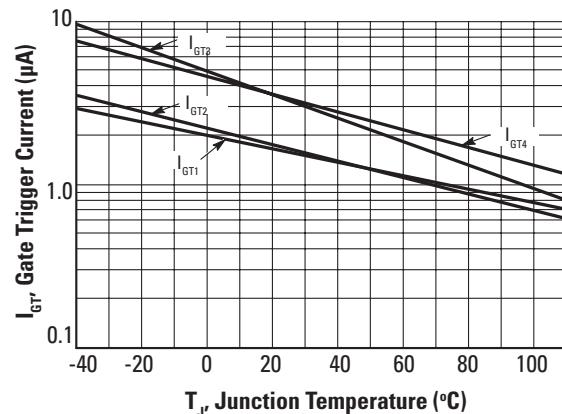


Figure 15. Typical Holding Current Variation

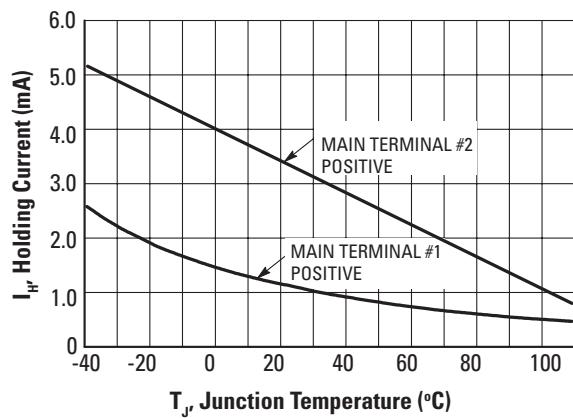
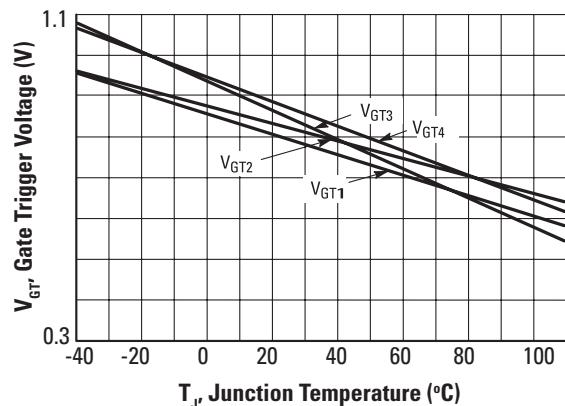
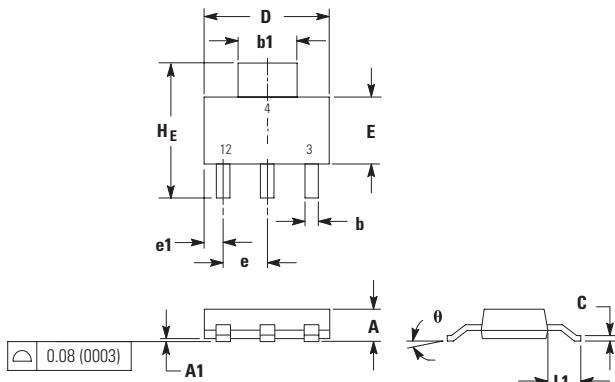


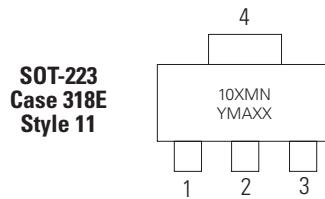
Figure 16. Gate Trigger Voltage Variation



## Dimensions



## Part Marking System



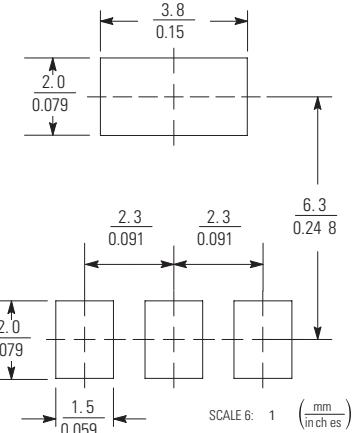
10XMN =Device Code  
 x =D, M, or N  
 Y =Year  
 M =Month  
 A =Assembly Site  
 XX =Lot Serial Code  
 G =Pb-Free Package

Dim	Inches			Millimeters		
	Min	Nom	Max	Min	Nom	Max
A	—	—	0.071	—	—	1.80
A1	0.001	0.003	0.005	0.02	0.07	0.13
b	0.026	0.030	0.033	0.66	0.75	0.84
b1	0.114	0.118	0.122	2.90	3.00	3.10
c	0.009	0.011	0.014	0.23	0.29	0.35
D	0.260	0.260	0.264	6.60	6.60	6.71
E	0.130	0.138	0.146	3.30	3.50	3.70
e	---	0.091	---	---	2.30	---
e1	0.030	0.037	0.045	0.75	0.95	1.15
L1	0.059	0.069	0.079	1.50	1.75	2.00
HE	0.264	0.276	0.287	6.7	7.00	7.3
$\theta$	0°	—	10°	0°	—	10°

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

## Soldering Footprint



## Ordering Information

Pin Assignment	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

Device	Package	Shipping
Z0103MNT1G	SOT-223 (Pb-Free)	1000 / Tape & Reel
Z0107MNT1G	SOT-223 (Pb-Free)	
Z0109MNT1G	SOT-223 (Pb-Free)	

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